

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): Xiaoju Wu

Art Unit: 2812

Division of Serial No.: 09/997,972

Examiner: Christopher W. Lattin

Filed: Herewith

Docket: TI-33005.1

For: Method for Manufacturing and Structure of Semiconductor Device with Polysilicon Definition Structure

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*Karen Vertz*  
Karen Vertz

9-19-03  
Date

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT**

Dear Sir:

Prior to the examination of the above-identified application, please amend as follows:

**IN THE SPECIFICATION:**

Please amend the Specification by inserting before the first line the following sentence:

--This is a division of Application No. 09/997,972, filed 11/29/2001, the entire disclosure of which is hereby incorporated herein by reference--.